

UNISONIC TECHNOLOGIES CO., LTD

5N40 **Power MOSFET**

TO-220

TO-220F1

TO-252

QW-R502-571.C

5A, 400V N-CHANNEL POWER MOSFET

DESCRIPTION

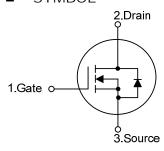
The UTC 5N40 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specializes in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 5N40 is universally applied in electronic lamp ballast based on half bridge topology and high efficient switched mode power supply.



- * $R_{DS(ON)}$ <1.20 @ V_{GS} =10V
- * High switching speed
- * 100% avalanche tested

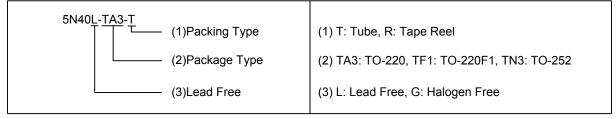
SYMBOL



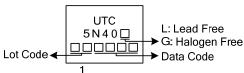
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
5N40L-TA3-T	5N40G-TA3-T	TO-220	G	D	S	Tube	
5N40L-TF1-T	5N40G-TF1-T	TO-220F1	G	D	S	Tube	
5N40L-TN3-R	5N40G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate S: Source D: Drain



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	400	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous (T _C =25°C)	l _D	5	Α
	Pulsed (Note 2)	I_{DM}	20	Α
Avalanche Current (Note 2)		I_{AR}	5	Α
Avalanche Energy	Single Pulsed (Note 3)	E_AS	300	mJ
	Repetitive (Note 2)	E_{AR}	7.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220		69	W
	TO-220F1	P_{D}	38	W
	TO-252		54	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 21.5mH, I_{AS} = 5A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 4. $I_{SD} \le 5A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambien	TO-220/TO-220F1	0	62.5	°C/W	
	TO-252	θја	110		
Junction to Case	TO-220		1.8	°C/W	
	TO-220F1	θ_{JC}	3.25		
	TO-252		2.13		

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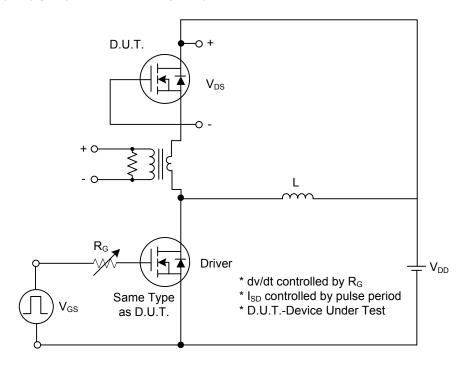
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS					•	•	
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	400			V
Breakdown Voltage Temperature			Reference to 25°C, I _D =250µA		0.4		V/°C
Coefficient		ZD V DSS/Z1J	1 tolorono to 20 0, 10 200p/ t		0.1		v , 0
Drain-Source Leakage Current		I _{DSS}	V _{DS} =400V, V _{GS} =0V			1	μΑ
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Re	sistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.5A		0.96	1.2	Ω
DYNAMIC PARAMETERS							
Input Capacitance	Input Capacitance				480	625	pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		80	105	pF
Reverse Transfer Capacitance		C _{RSS}			15	20	рF
SWITCHING PARAMETERS							
Total Gate Charge		Q_{G}	101/1/ 0001/1 54		18	24	nC
Gate to Source Charge		Q_{GS}	V _{GS} =10V, V _{DS} =320V, I _D =5A		2.2		nC
Gate to Drain Charge		Q_{GD}	(Note 1, 2)		9.7		nC
Turn-ON Delay Time		t _{D(ON)}			12	35	ns
Rise Time		t _R	V_{DD} =200V, I_{D} =5A, R_{G} =25 Ω		46	100	ns
Turn-OFF Delay Time		t _{D(OFF)}	(Note 1, 2)		50	110	ns
Fall-Time		t _F	Γ		48	105	ns
SOURCE- DRAIN DIODE RATIN	NGS AND	CHARACTERIS	STICS	•	•	•	
Maximum Body-Diode Continuous Current		I _S				5	Α
Maximum Body-Diode Pulsed Current		I _{SM}				20	Α
Drain-Source Diode Forward Voltage		V _{SD}	I _S =5A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =5A, V _{GS} =0V, dI _F /dt=100A/µs		263		ns
Body Diode Reverse Recovery Charge		Q _{RR}	(Note 1)		1.9		μC

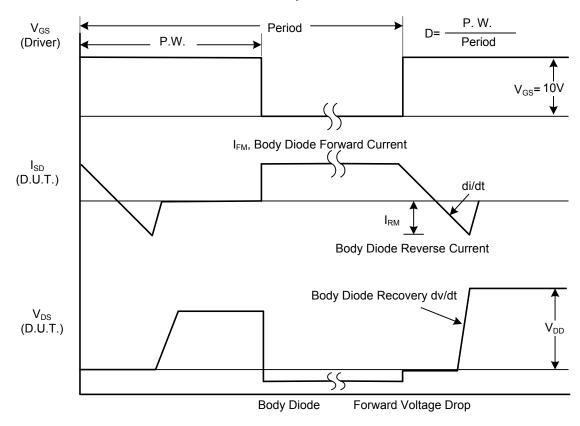
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

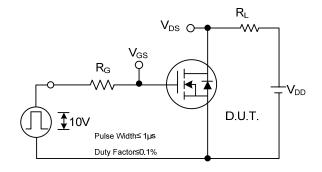


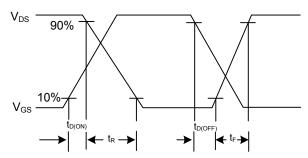
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

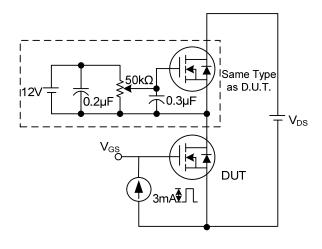
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

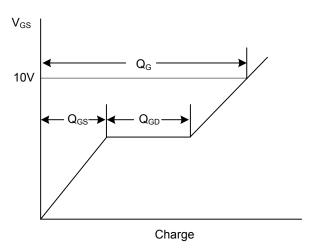




Switching Test Circuit

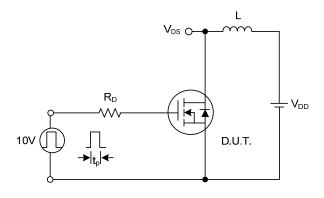
Switching Waveforms

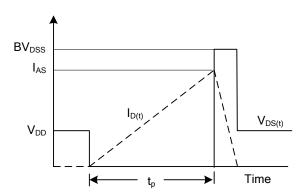




Gate Charge Test Circuit

Gate Charge Waveform



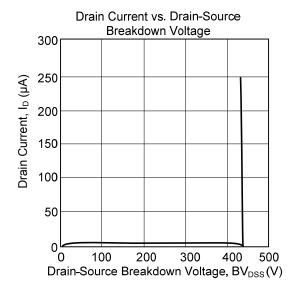


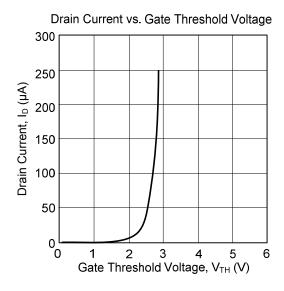
Unclamped Inductive Switching Test Circuit

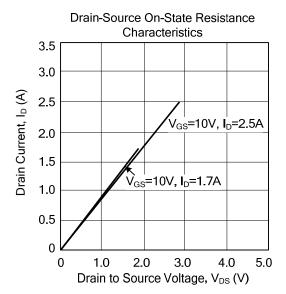
Unclamped Inductive Switching Waveforms

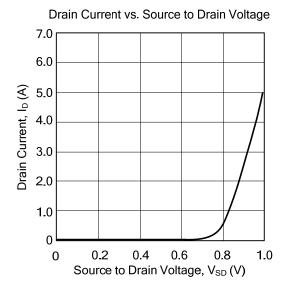
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■ TYPICAL CHARACTERISTICS









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